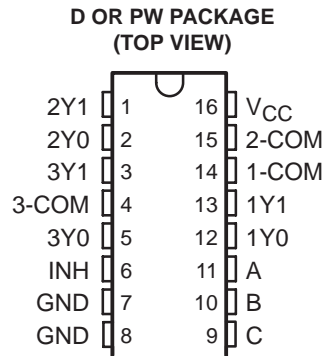


SN74LV4053A-Q1

TRIPLE 2-CHANNEL ANALOG MULTIPLEXER/DEMULPLEXER

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- Qualified for Automotive Applications
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- 2-V to 5.5-V V_{CC} Operation
- Supports Mixed-Mode Voltage Operation on All Ports
- High On-Off Output-Voltage Ratio
- Low Crosstalk Between Switches
- Individual Switch Controls
- Extremely Low Input Current



description/ordering information

This triple 2-channel CMOS analog multiplexer/demultiplexer is designed for 2-V to 5.5-V V_{CC} operation.

The SN74LV4053A handles both analog and digital signals. Each channel permits signals with amplitudes up to 5.5 V (peak) to be transmitted in either direction.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

ORDERING INFORMATION†

T _A	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 105°C	SOIC – D	Tape and reel	SN74LV4053ATDRQ1	L4053AQ
	TSSOP – PW	Tape and reel	SN74LV4053ATPWRQ1	L4053AQ

† For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at <http://www.ti.com>.

‡ Package drawings, thermal data, and symbolization are available at <http://www.ti.com/packaging>.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
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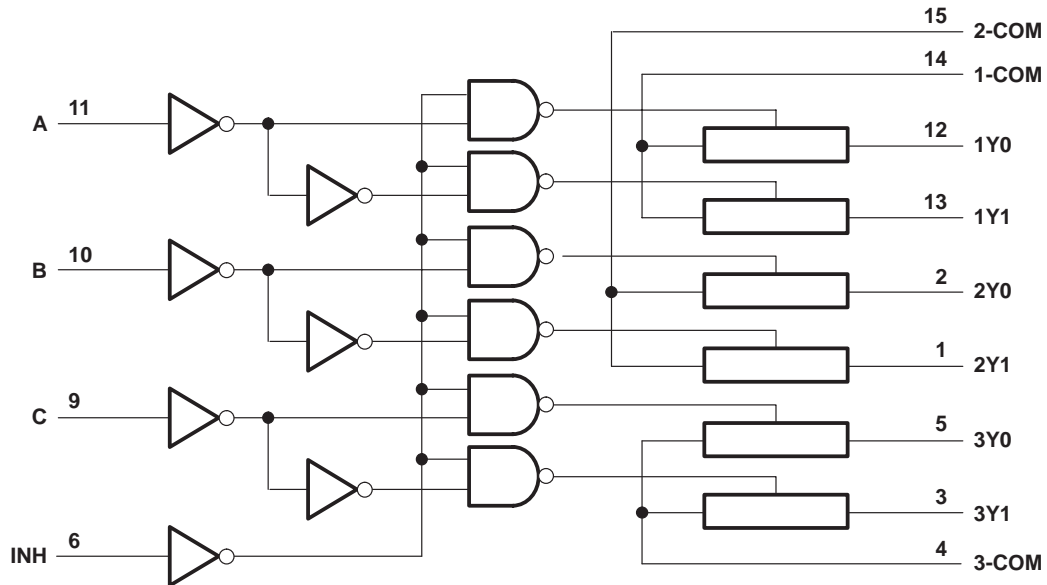
TRIPLE 2-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

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FUNCTION TABLE

INPUTS				ON CHANNELS
INH	C	B	A	
L	L	L	L	1Y0, 2Y0, 3Y0
L	L	L	H	1Y1, 2Y0, 3Y0
L	L	H	L	1Y0, 2Y1, 3Y0
L	L	H	H	1Y1, 2Y1, 3Y0
L	H	L	L	1Y0, 2Y0, 3Y1
L	H	L	H	1Y1, 2Y0, 3Y1
L	H	H	L	1Y0, 2Y1, 3Y1
L	H	H	H	1Y1, 2Y1, 3Y1
H	X	X	X	None

logic diagram (positive logic)



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TRIPLE 2-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7.0 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7.0 V
Switch I/O voltage range, V_{IO} (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
I/O diode current, I_{IOK} ($V_{IO} < 0$)	–50 mA
Switch through current, I_T ($V_{IO} = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 3): D package	73°C/W
PW package	108°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. This value is limited to 5.5 V maximum.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

		MIN	MAX	UNIT
V_{CC}	Supply voltage	2‡	5.5	V
V_{IH}	High-level input voltage, control inputs	$V_{CC} = 2$ V	1.5	V
		$V_{CC} = 2.3$ V to 2.7 V	$V_{CC} \times 0.7$	
		$V_{CC} = 3$ V to 3.6 V	$V_{CC} \times 0.7$	
		$V_{CC} = 4.5$ V to 5.5 V	$V_{CC} \times 0.7$	
V_{IL}	Low-level input voltage, control inputs	$V_{CC} = 2$ V	0.5	V
		$V_{CC} = 2.3$ V to 2.7 V	$V_{CC} \times 0.3$	
		$V_{CC} = 3$ V to 3.6 V	$V_{CC} \times 0.3$	
		$V_{CC} = 4.5$ V to 5.5 V	$V_{CC} \times 0.3$	
V_I	Control input voltage	0	5.5	V
V_{IO}	Input/output voltage	0	V_{CC}	V
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 2.3$ V to 2.7 V	200	ns/V
		$V_{CC} = 3$ V to 3.6 V	100	
		$V_{CC} = 4.5$ V to 5.5 V	20	
T_A	Operating free-air temperature	–40	105	°C

‡ With supply voltages at or near 2 V, the analog switch on-state resistance becomes very nonlinear. It is recommended that only digital signals be transmitted at these low supply voltages.

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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TRIPLE 2-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
r _{on} On-state switch resistance	I _T = 2 mA, V _I = V _{CC} or GND, V _{INH} = V _{IL} (see Figure 1)	2.3 V		41	180		225	Ω
		3 V		30	150		190	
		4.5 V		23	75		100	
r _{on(p)} Peak on-state resistance	I _T = 2 mA, V _I = V _{CC} to GND, V _{INH} = V _{IL}	2.3 V		139	500		600	Ω
		3 V		63	180		225	
		4.5 V		35	100		125	
Δr _{on} Difference in on-state resistance between switches	I _T = 2 mA, V _I = V _{CC} to GND, V _{INH} = V _{IL}	2.3 V		2	30		40	Ω
		3 V		1.6	20		30	
		4.5 V		1.3	15		20	
I _I Control input current	V _I = 5.5 V or GND	0 to 5.5 V				±0.1	±1	μA
I _{S(off)} Off-state switch leakage current	V _I = V _{CC} and V _O = GND, or V _I = GND and V _O = V _{CC} , V _{INH} = V _{IH} (see Figure 2)	5.5 V				±0.1	±1	μA
I _{S(on)} On-state switch leakage current	V _I = V _{CC} or GND, V _{INH} = V _{IH} (see Figure 3)	5.5 V				±0.1	±1	μA
I _{CC} Supply current	V _I = V _{CC} or GND	5.5 V					20	μA
C _{IC} Control input capacitance				2				pF
C _{IS} Common terminal capacitance				8.2				pF
C _{OS} Switch terminal capacitance				5.6				pF
C _F Feedthrough capacitance				0.5				pF

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	T _A = 25°C			MIN	MAX	UNIT
				MIN	TYP	MAX			
t _{PLH} Propagation delay time	COM or Y _n	Y _n or COM	C _L = 50 pF, (see Figure 4)		2.9	9		12	ns
t _{PZH} Enable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)		6.1	20		25	ns
t _{PZL} Disable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)		8.9	20		25	ns



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TRIPLE 2-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

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**switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	T _A = 25°C			MIN	MAX	UNIT
				MIN	TYP	MAX			
t _{PLH} t _{PHL} Propagation delay time	COM or Y _n	Y _n or COM	C _L = 50 pF, (see Figure 4)	1.8	6		8	ns	
t _{PZH} t _{PZL} Enable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)	4.3	14		18	ns	
t _{PHZ} t _{PLZ} Disable delay time	INH	COM or Y _n	C _L = 50 pF, (see Figure 5)	6.3	14		18	ns	

analog switch characteristics

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V _{CC}	T _A = 25°C			UNIT	
					MIN	TYP	MAX		
Frequency response (switch on)	COM or Y _n	Y _n or COM	C _L = 50 pF, R _L = 600 Ω, f _{in} = 1 MHz (sine wave) (see Note 5 and Figure 6)	2.3 V	30			MHz	
				3 V	35				
				4.5 V	50				
Crosstalk (between any switches)	COM or Y _n	Y _n or COM	C _L = 50 pF, R _L = 600 Ω, f _{in} = 1 MHz (sine wave) (see Note 6 and Figure 7)	2.3 V	-45			dB	
				3 V	-45				
				4.5 V	-45				
Crosstalk (control input to signal output)	INH	COM or Y _n	C _L = 50 pF, R _L = 600 Ω, f _{in} = 1 MHz (square wave) (see Figure 8)	2.3 V	20			mV	
				3 V	35				
				4.5 V	65				
Feedthrough attenuation (switch off)	COM or Y _n	Y _n or COM	C _L = 50 pF, R _L = 600 Ω, f _{in} = 1 MHz (see Note 6 and Figure 9)	2.3 V	-45			dB	
				3 V	-45				
				4.5 V	-45				
Sine-wave distortion	COM or Y _n	Y _n or COM	C _L = 50 pF, R _L = 10 kΩ, f _{in} = 1 kHz (sine wave) (see Figure 10)	V _I = 2 V _{p-p}	2.3 V	0.1			%
				V _I = 2.5 V _{p-p}	3 V	0.1			
				V _I = 4 V _{p-p}	4.5 V	0.1			

NOTES: 5. Adjust f_{in} voltage to obtain 0-dBm output. Increase f_{in} frequency until dB meter reads -3 dB.
6. Adjust f_{in} voltage to obtain 0-dBm input.

operating characteristics, V_{CC} = 3.3 V, T_A = 25°C

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	C _L = 50 pF, f = 10 MHz	5.3	pF



SN74LV4053A-Q1 TRIPLE 2-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

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PARAMETER MEASUREMENT INFORMATION

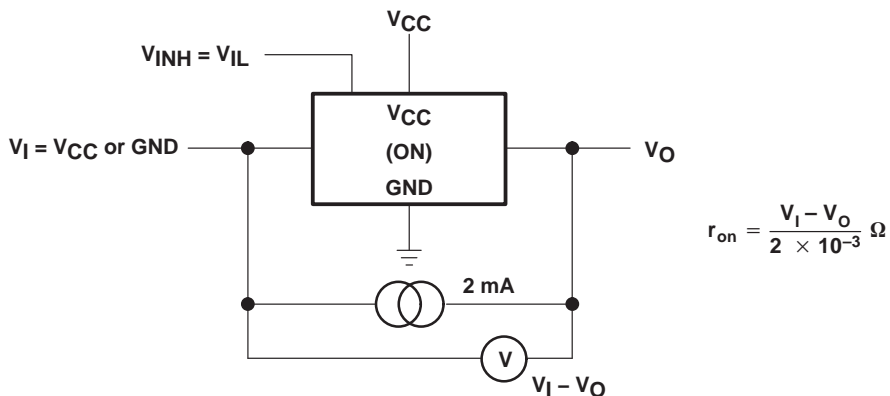


Figure 1. On-State Resistance Test Circuit

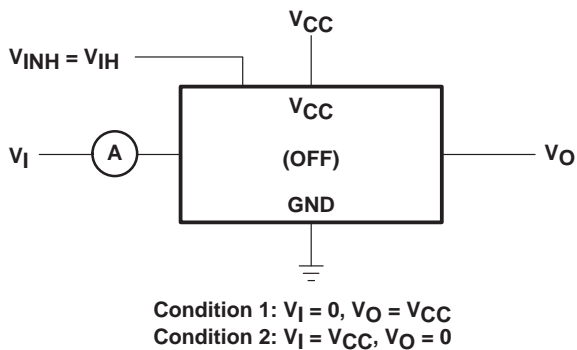


Figure 2. Off-State Switch Leakage-Current Test Circuit

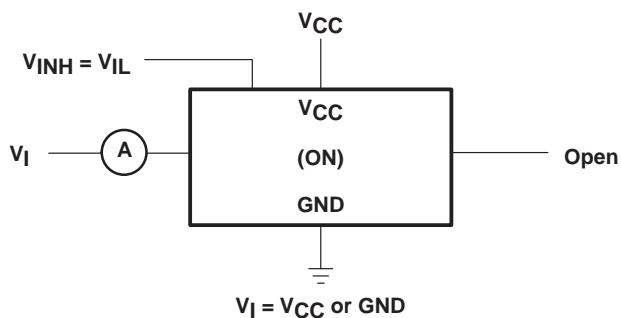


Figure 3. On-State Switch Leakage-Current Test Circuit

PARAMETER MEASUREMENT INFORMATION

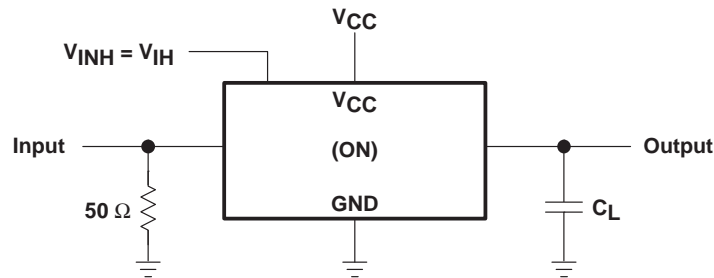
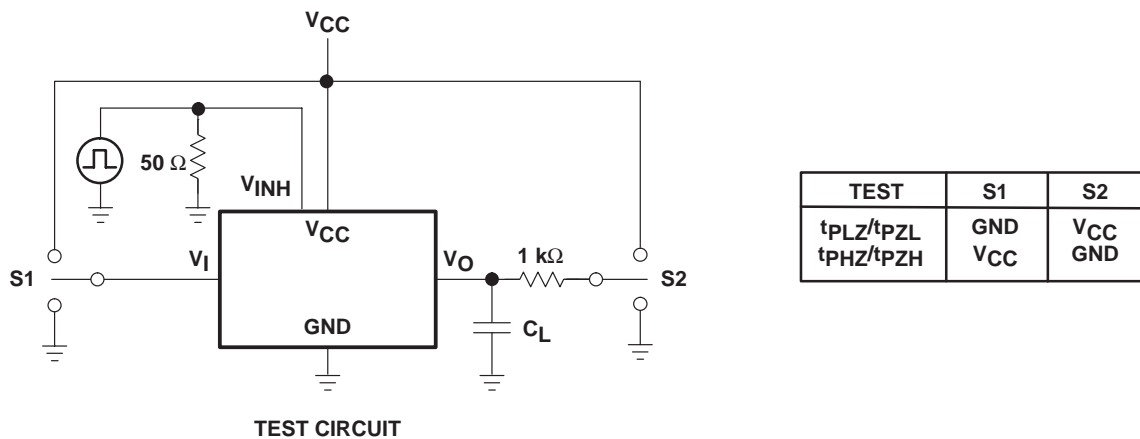


Figure 4. Propagation Delay Time, Signal Input to Signal Output



TEST CIRCUIT

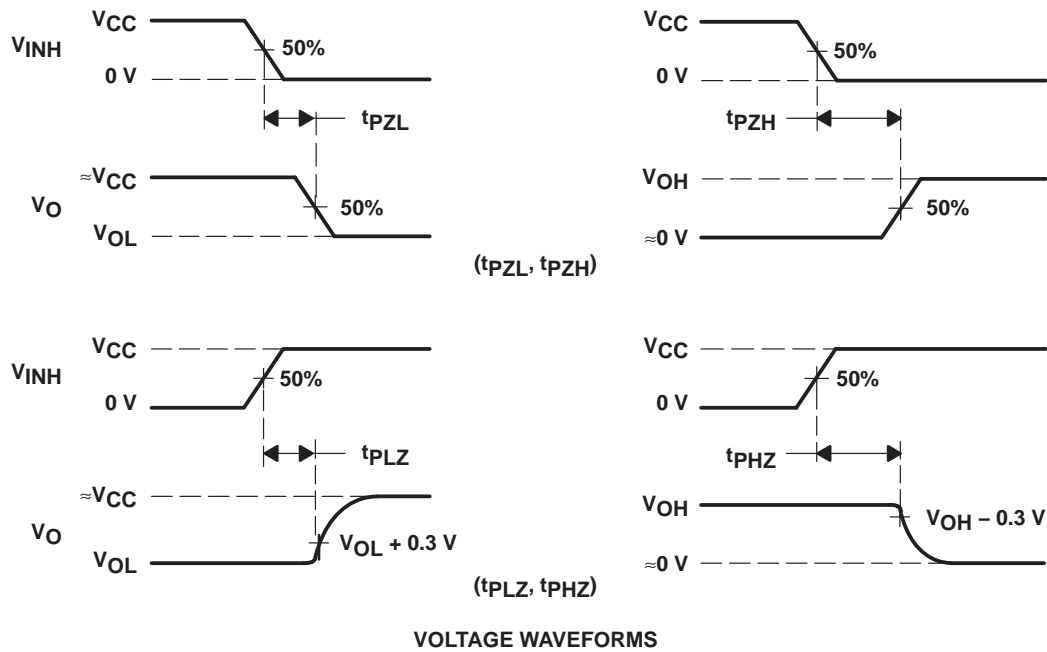
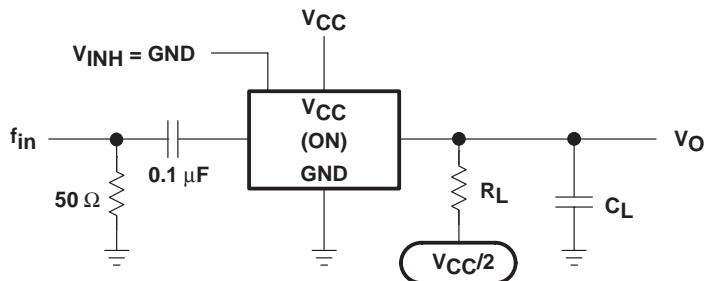


Figure 5. Switching Time (t_{PZL} , t_{PLZ} , t_{PZH} , t_{PHZ}), Control to Signal Output

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PARAMETER MEASUREMENT INFORMATION



NOTE A: f_{in} is a sine wave.

Figure 6. Frequency Response (Switch On)

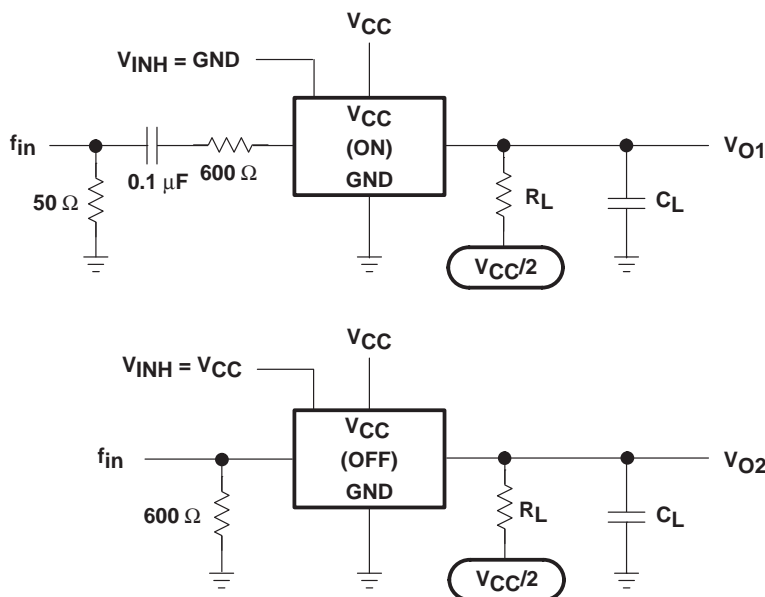


Figure 7. Crosstalk Between Any Two Switches

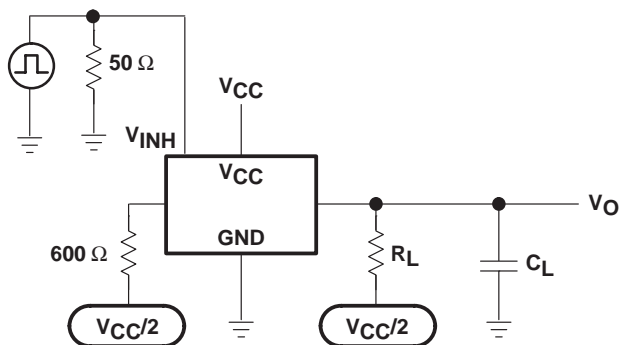


Figure 8. Crosstalk Between Control Input and Switch Output

PARAMETER MEASUREMENT INFORMATION

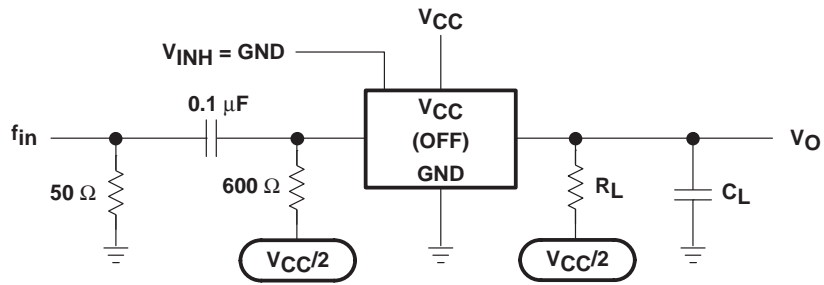


Figure 9. Feedthrough Attenuation (Switch Off)

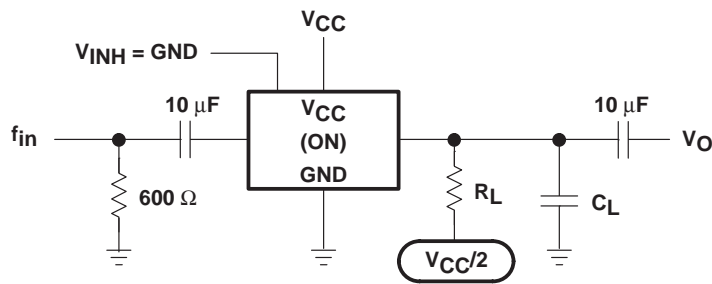


Figure 10. Sine-Wave Distortion

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CLV4053ATPWRG4Q1	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV4053ATDRQ1	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LV4053ATPWRQ1	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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- Catalog: [SN74LV4053A](#)
- Enhanced Product: [SN74LV4053A-EP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
 - E. Reference JEDEC MS-012 variation AC.

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